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APPROVAL SHEET

Customer:	
Part Number:	
Part No.:	11420010000.0005
Holder:	OCXO-20
Frequency:	10.000MHz
Manufacturer:	
Date:	2023/3/24

Prepared	Checked	Approved

(For Customer Use)

Acceptable	Non-Acceptable

Revision History

No.	Revised Date	Change Content	Approved	Remark
1.0	2023-3-24	Initial Release		

1. Scope

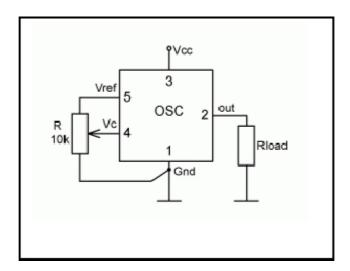
This document describes technical guidelines of product 11420010000.0005

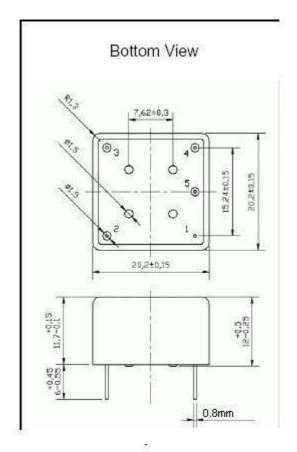
2. Electrical Characteristics

		SINEWAVE OUTPUT O	CXO-20			
PARAMETER	SYMBOL	CONDITIONS	MIN	TYPE	MAX	UNIT
Normal Frequency	Fn	SC	-	10.000	-	MHz
Absolute maxin	num ratings					
Maximum Supply Range	V _{cc}	-	-0.5	-	+6	V
Operating Temperature range	T _A	-	-40	-	75	°C
Storage Temperature range	-	-	-55	-	125	°C
Power						
Operating Supply Voltage	Vcc		4.75	5.00	5.25	V
Turn-On Power	-	Nom Vcc	-	-	3.6	W
Steady state Power	-	Ta=25℃	-	-	1.2	W
Frequency Stat	oility					
Calibration	-	T _A =25℃	-	±100	±200	ppb
Freq VS Temperature	Ts	-40°C to 75°C(ref to 25°C)	-100	-	+100	ppb
Freq. VS Voltage	-	Vcc=5V±5% (Vc= constant)	-30	-	+30	ppb
Freq. VS Load	-	Load = 50 Ohm±5%	-30	-	+30	ppb
Short term Frequency Stability	-	1S		≤5E-11		
	-	Per day	-	-	±1	ppb
Freq VS Time (Aging)	-	Per year	-	-	±100	ppb
(e e.	-	10 years	-	-	±300	ppb
Warm up time		to within $F \pm 1$ E-7 where F			≤5	minutes

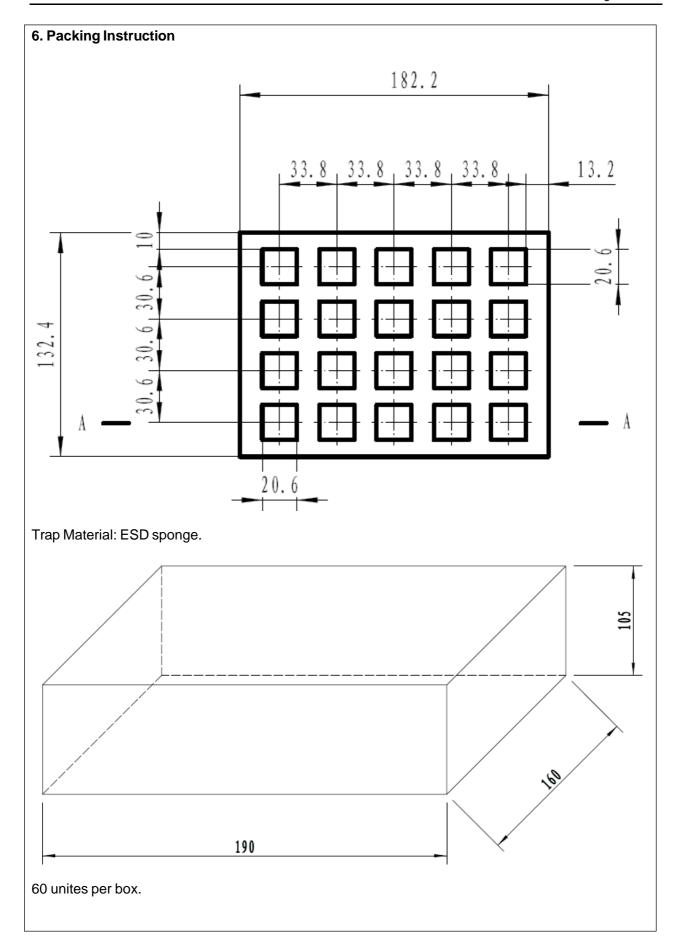
		is the frequency reached after 1 hour of continuous operation				
Electronic Freq	uency Cor	itrol				
Control Range	Vc	-	0.0	-	5.0	V
Center control voltage	-	25°C at time of shipment	-	2.25	-	V
Frequency pull	-	Vc=0.0V	-	-	-0.7	ppm
Range	-	Vc=4.5V	+0.7	-	-	ppm
Frequency pull slope	-	-		Positive		
Vc port impedance	-	-	-	100	-	ΚΩ
Linerity	Lin	-	-10	-	10	%
Output Paramet	ters					
Output signal	-	-		SINEWAVE		-
Output load	-	Output to ground	Loa	ad=50 Ohm:	±5%	-
Output level	-	-	+2		-	dBm
Harmonics	-	-	-	-	-25	dBc
Spurious	-	-	-	-	-75	dBc
Reference voltage	Vref	-	4.8	5.0	5.2	VDC
Phase noise						
	-	10Hz	-	-110	-	dBc/Hz
	-	100Hz	-	-135	-	dBc/Hz
	-	1KHz	-	-145	-	dBc/Hz
	-	10KHz	-	-150	-	dBc/Hz
.Construction . Oscillator encl □ Seam se		sistance weld □cold weld				
2. crystal enclosure medium						
□nitrogen		acuum □dry air				

4.Dimension:





5. Marking		
■Laser Marking	☐ Ink Marking	
	g	
Example		



Per. Spec.

7. Reliability characteristic: Item Condition **Specifications** 7.1 Reflow ΔF≤±0.2ppm 3X 240°C Peak Simulation 20 secs max above 240°C 7.2 Power Cycle 100 Cycles ∆F≤±0.2ppm -40°C, 30 minutes no power (off) and 30 minutes powered (on) -- Test product for functionality -- Continue for another 250 cycles -- Test product for functionality -- Intenal visual and mechanical inspection 7.3 Thermal Shock Subject samples to temperature extremes of -40 and ∆F≤±0.2ppm +125C, 30 minute soaks at the temperature extremes, 10 seconds maximum transition time between extremes. The test duration is 10 Cycles GJB 360A-96 Method 107. Mechanical Subject OCXO to 500 g's, half-sine, pulse width of 1 ms 7.4 ΔF≤±0.2ppm Shock for double ovens; 1000 g's, half-sine, pulse width of 1 ms for single ovens, five shocks in each of 6 directions of 3 perpendicular planes, for a total of 30 shocks. After shock, check with final test. GJB 360A-96 Method 213 Vibrate oscillators sinusoidally from 10 Hz to 55 Hz with 7.5 Vibration ΔF≤±0.2ppm a double amplitude of 0.60" and from 55 Hz to 500 Hz with a peak acceleration of 10 g's for 30 minutes in each of three perpendicular directions. Oscillators to be checked with final test after vibration. GB2423.10-1995 (idt IEC 68-2-6:1982) Method Fc. 7.6 Free drop ∆F≤±0.2ppm Drop from 10cm height on 3cm hard wooden board for 6 times

GB2423.8-1995 (idt IEC 68-2-32:1990) Method Ed.

oscillators to 25C for 1008 hours. Readings are to be

taken with oscillator at 25C twice per day. Determine

aging (frequency shift post 1008 hours minus initial

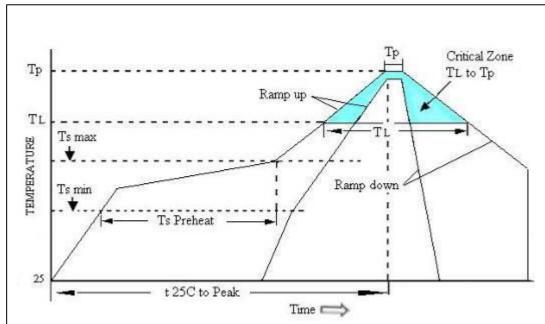
Bias oscillators at nominal voltage and subject

7.7

Aging

		frequency). Use the results to predict long-term aging.	
8	Solderability	Precondition parts by steaming (over boiling water) for 8 hours OR age the parts at 150C for 16 hours	A new uniform coating of solder shall cover a minimum of 95% of the surface being immersed.
			immersed.
λII	products are R	RoHs compliant	

9. Reflow Profile



High Temperature Infrared /Convection

Note:Temperature shown are applied to body of device

Ts max to T _L (Ramp-up Rate)	3°C/second max	
Preheat		
Temperature Min(Ts Min)	150℃	
Temperature Typical(Ts Typ)	175℃	
Temperature Max.(Ts Max)	200℃	
Time(ts)	60-180 seconds	
Ram-up Rate(T _L to Tp)	3°C/second Max	
Time Maintained Above:		
Temperature(T _L)	217℃	
Time(T _L)	60-150seconds	
Peak Temperature (Tp)	260°C Max for 10 seconds	
Time within 5°C of actual peak(t _p)	20-40 seconds	
Ramp-down Rate	6°C/seconds Max	
Tune 25°C to Peak Temperature(t)	8 minutes Max	
Moisture Sensitivity Level	Level 1	

High Temperature Manual Soldering

Note:Temperature shown are applied to body of device